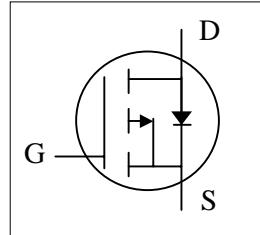




▼ Low Gate Charge

▼ Simple Drive Requirement

▼ Fast Switching

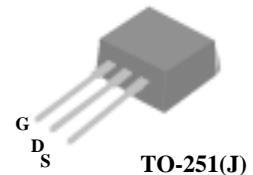


BV_{DSS}	-30V
$R_{DS(ON)}$	200m Ω
I_D	- 10A

Description

Advanced Power MOSFETs utilized advanced processing techniques to achieve the lowest possible on-resistance, extremely efficient and cost-effectiveness device.

The TO-252/TO-251 package is universally used for all commercial-industrial application.



Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	- 30	V
V_{GS}	Gate-Source Voltage	± 20	V
$I_D @ T_A=25^\circ\text{C}$	Continuous Drain Current	-10	A
$I_D @ T_A=70^\circ\text{C}$	Continuous Drain Current	-8.6	A
I_{DM}	Pulsed Drain Current ¹	-48	A
$P_D @ T_A=25^\circ\text{C}$	Total Power Dissipation	36.7	W
	Linear Derating Factor	0.29	W/ $^\circ\text{C}$
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ\text{C}$
T_J	Operating Junction Temperature Range	-55 to 150	$^\circ\text{C}$

Thermal Data

Symbol	Parameter	Value	Unit
$R_{thj-case}$	Thermal Resistance Junction-case	Max.	$^\circ\text{C}/\text{W}$
$R_{thj-amb}$	Thermal Resistance Junction-ambient	Max.	$^\circ\text{C}/\text{W}$



Electrical Characteristics@ $T_j=25^\circ\text{C}$ (unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$, $I_{\text{D}}=-250\mu\text{A}$	-30	-	-	V
$\Delta \text{BV}_{\text{DSS}}/\Delta T_j$	Breakdown Voltage Temperature Coefficient	Reference to 25°C , $I_{\text{D}}=-1\text{mA}$	-	-0.1	-	$\text{V}/^\circ\text{C}$
$R_{\text{DS}(\text{ON})}$	Static Drain-Source On-Resistance ²	$V_{\text{GS}}=-10\text{V}$, $I_{\text{D}}=-6\text{A}$	-	-	200	$\text{m}\Omega$
		$V_{\text{GS}}=-4.5\text{V}$, $I_{\text{D}}=-4\text{A}$	-	-	400	$\text{m}\Omega$
$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$, $I_{\text{D}}=-250\mu\text{A}$	-1	-	-3	V
g_{fs}	Forward Transconductance	$V_{\text{DS}}=-10\text{V}$, $I_{\text{D}}=-6\text{A}$	-	2	-	S
I_{DSS}	Drain-Source Leakage Current ($T_j=25^\circ\text{C}$)	$V_{\text{DS}}=-30\text{V}$, $V_{\text{GS}}=0\text{V}$	-	-	-1	uA
	Drain-Source Leakage Current ($T_j=150^\circ\text{C}$)	$V_{\text{DS}}=-24\text{V}$, $V_{\text{GS}}=0\text{V}$	-	-	-25	uA
I_{GSS}	Gate-Source Leakage	$V_{\text{GS}}= \pm 20\text{V}$	-	-	± 100	nA
Q_g	Total Gate Charge ²	$I_{\text{D}}=-6\text{A}$	-	3.8	-	nC
Q_{gs}	Gate-Source Charge	$V_{\text{DS}}=-15\text{V}$	-	1.7	-	nC
Q_{gd}	Gate-Drain ("Miller") Charge	$V_{\text{GS}}=-4.5\text{V}$	-	1.6	-	nC
$t_{\text{d}(\text{on})}$	Turn-on Delay Time ²	$V_{\text{DS}}=-15\text{V}$	-	6.7	-	ns
t_r	Rise Time	$I_{\text{D}}=-6\text{A}$	-	20.8	-	ns
$t_{\text{d}(\text{off})}$	Turn-off Delay Time	$R_G=2\Omega$, $V_{\text{GS}}=-10\text{V}$	-	14.9	-	ns
t_f	Fall Time	$R_D=2.5\Omega$	-	4.4	-	ns
C_{iss}	Input Capacitance	$V_{\text{GS}}=0\text{V}$	-	217	-	pF
C_{oss}	Output Capacitance	$V_{\text{DS}}=-25\text{V}$	-	103	-	pF
C_{rss}	Reverse Transfer Capacitance	f=1.0MHz	-	31	-	pF

Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V_{SD}	Forward On Voltage ²	$I_{\text{S}}=-1.25\text{A}$, $V_{\text{GS}}=0\text{V}$	-	-	-1.2	V
trr	Reverse Recovery Time	$I_{\text{S}}=-6\text{A}$, $V_{\text{GS}}=0\text{V}$,	-	35	-	ns
Qrr	Reverse Recovery Charge	$dI/dt=-100\text{A}/\mu\text{s}$	-	63	-	nC

Notes:

- 1.Pulse width limited by Max. junction temperature.
- 2.Pulse width $\leq 300\text{us}$, duty cycle $\leq 2\%$.

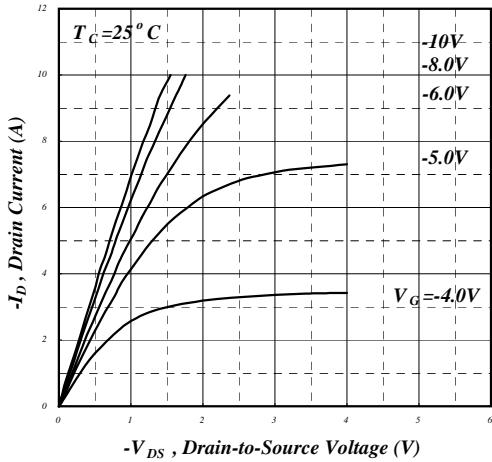


Fig 1. Typical Output Characteristics

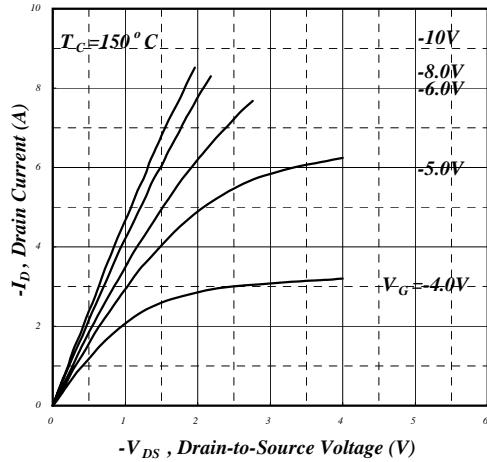


Fig 2. Typical Output Characteristics

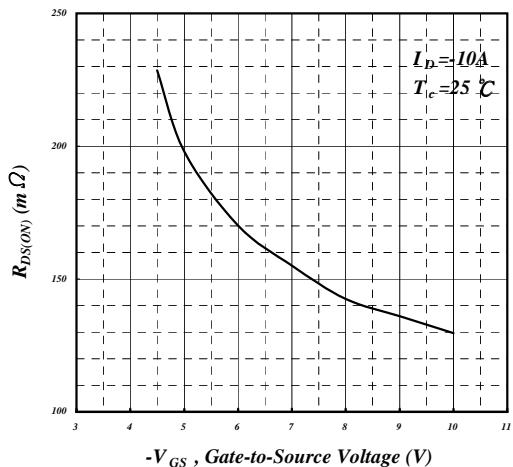


Fig 3. On-Resistance v.s. Gate Voltage

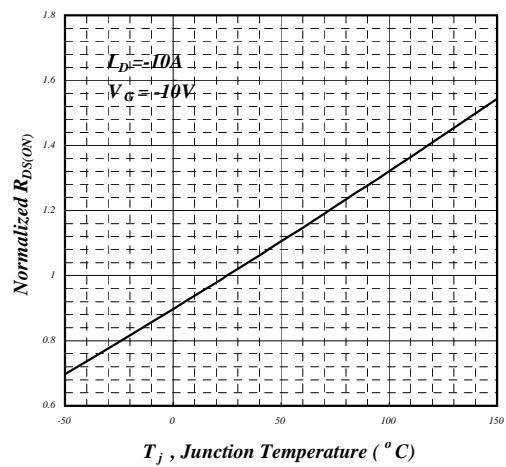


Fig 4. Normalized On-Resistance v.s. Junction Temperature

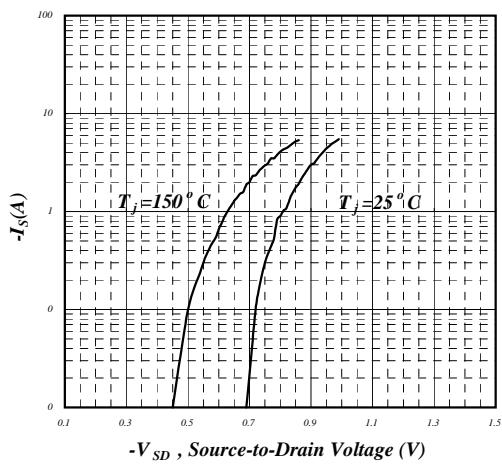


Fig 5. Forward Characteristic of Reverse Diode

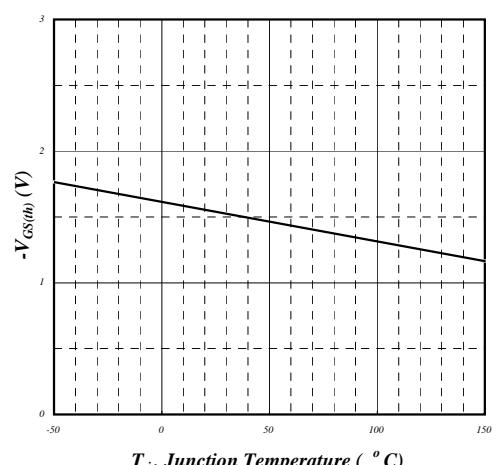


Fig 6. Gate Threshold Voltage v.s. Junction Temperature

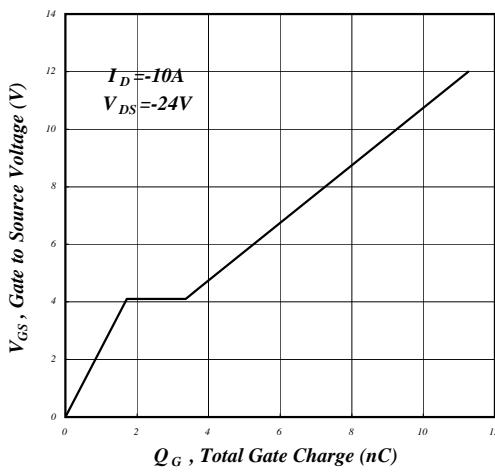


Fig 7. Gate Charge Characteristics

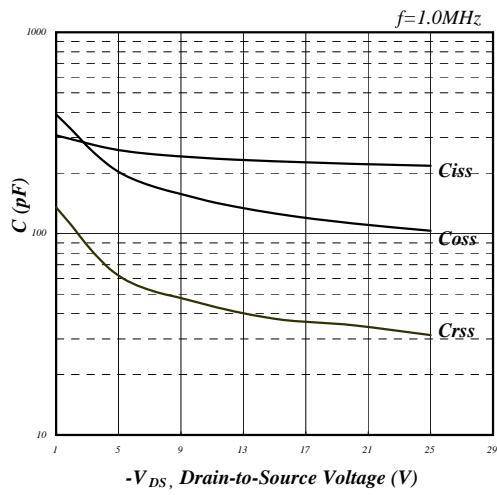


Fig 8. Typical Capacitance Characteristics

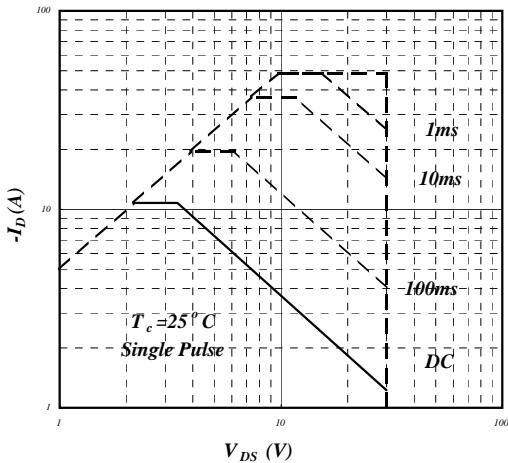


Fig 9. Maximum Safe Operating Area

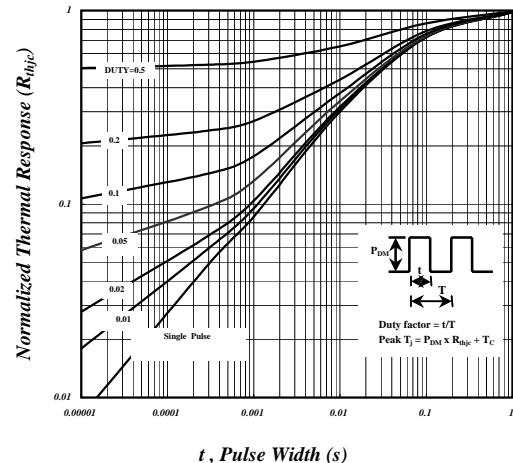


Fig 10. Effective Transient Thermal Impedance

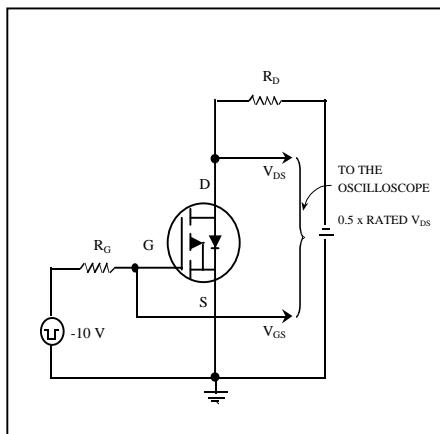


Fig 11. Switching Time Circuit

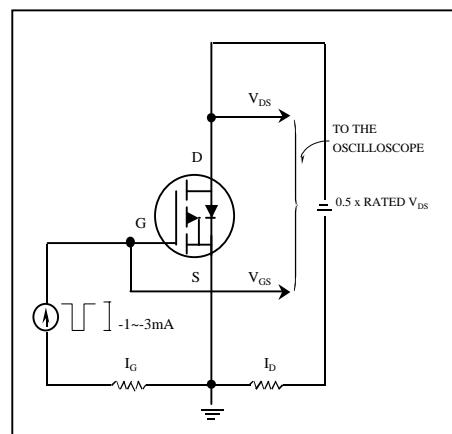


Fig 12. Gate Charge Circuit